

FGY75T120SQDN

Ultra Field Stop IGBT, 1200 V, 75 A

General Description

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Ultra Field Stop construction, and provides superior performance in demanding switching applications, offering both low on-state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

Features

- Extremely Efficient Trench with Field Stop Technology
- Maximum Junction Temperature: $T_J = 175^\circ\text{C}$
- Low Saturation Voltage: $V_{CE(sat)} = 1.7\text{ V (Typ.) @ } I_C = 75\text{ A}$
- 100% of the Parts Tested for $I_{LM}(1)$
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- RoHS Compliant

Applications

- Solar Inverter, UPS

ABSOLUTE MAXIMUM RATINGS

($T_J = 25^\circ\text{C}$ unless otherwise stated)

Symbol	Parameter	Value	Unit
V_{CES}	Collector to Emitter Voltage	1200	V
V_{GES}	Gate to Emitter Voltage	± 20	V
	Transient Gate to Emitter Voltage	± 30	V
I_C	Collector Current @ $T_C = 25^\circ\text{C}$	150	A
	Collector Current @ $T_C = 100^\circ\text{C}$	75	A
$I_{LM}(1)$	Pulsed Collector Current @ $T_C = 25^\circ\text{C}$	300	A
$I_{CM}(2)$	Pulsed Collector Current	300	A
I_F	Diode Forward Current @ $T_C = 25^\circ\text{C}$	150	A
	Diode Forward Current @ $T_C = 100^\circ\text{C}$	75	A
I_{FM}	Pulsed Diode Max. Forward Current	300	A
P_D	Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$	790	W
	@ $T_C = 100^\circ\text{C}$	395	
T_J	Operating Junction Temperature	-55 to +175	$^\circ\text{C}$
T_{stg}	Storage Temperature Range	-55 to +175	$^\circ\text{C}$
T_L	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 s	300	$^\circ\text{C}$

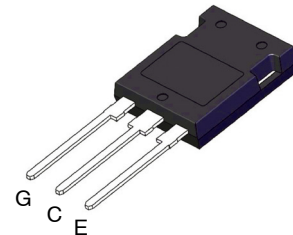
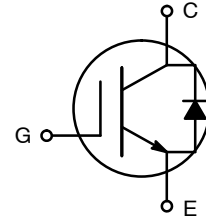
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. $V_{CC} = 800\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 300\text{ A}$, $R_G = 68\ \Omega$, Inductive Load.
2. Repetitive rating: Pulse width limited by max. junction temperature.



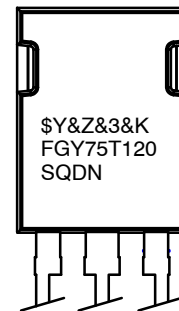
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TO-247-3LD
CASE 340CD

MARKING DIAGRAM



&Y = ON Semiconductor Logo
&Z = Assembly Plant Code
&3 = Date Code (Year & Week)
&K = Lot Run Traceability Code
FGY75T120SQDN = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 3 of this data sheet.

FGY75T120SQDN

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case, Max.	0.19	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	0.38	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W

ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

BV_{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0\text{ V}, I_C = 500\ \mu\text{A}$	1200	-	-	V
I_{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0\text{ V}$	-	-	400	μA
I_{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0\text{ V}$	-	-	± 200	nA

ON CHARACTERISTICS

$V_{GE(th)}$	G-E Threshold Voltage	$I_C = 400\ \mu\text{A}, V_{CE} = V_{GE}$	4.5	5.5	6.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C = 75\text{ A}, V_{GE} = 15\text{ V}$	-	1.7	1.95	V
		$I_C = 75\text{ A}, V_{GE} = 15\text{ V}, T_C = 175^\circ\text{C}$	-	2.3	-	V

DYNAMIC CHARACTERISTICS

C_{ies}	Input Capacitance	$V_{CE} = 20\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$	-	9060	-	pF
C_{oes}	Output Capacitance		-	242	-	pF
C_{res}	Reverse Transfer Capacitance		-	137	-	pF

SWITCHING CHARACTERISTICS

$t_{d(on)}$	Turn-On Delay Time	$V_{CC} = 600\text{ V}, I_C = 75\text{ A}, R_G = 10\ \Omega, V_{GE} = 15\text{ V},$ Inductive Load, $T_C = 25^\circ\text{C}$	-	64	-	ns
t_r	Rise Time		-	96	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	332	-	ns
t_f	Fall Time		-	28	-	ns
E_{on}	Turn-On Switching Loss		-	6.25	-	mJ
E_{off}	Turn-Off Switching Loss		-	1.96	-	mJ
E_{ts}	Total Switching Loss		-	8.21	-	mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC} = 600\text{ V}, I_C = 75\text{ A}, R_G = 10\ \Omega, V_{GE} = 15\text{ V},$ Inductive Load, $T_C = 175^\circ\text{C}$	-	56	-	ns
t_r	Rise Time		-	80	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	364	-	ns
t_f	Fall Time		-	88	-	ns
E_{on}	Turn-On Switching Loss		-	8.67	-	mJ
E_{off}	Turn-Off Switching Loss		-	3.2	-	mJ
E_{ts}	Total Switching Loss		-	11.87	-	mJ
Q_g	Total Gate Charge	$V_{CE} = 600\text{ V}, I_C = 75\text{ A}, V_{GE} = 15\text{ V}$	-	399	-	nC
Q_{ge}	Gate to Emitter Charge		-	74	-	nC
Q_{gc}	Gate to Collector Charge		-	192	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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ELECTRICAL CHARACTERISTICS OF THE DIODE ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit	
V_{FM}	Diode Forward Voltage	$I_F = 75\text{ A}$	$T_C = 25^\circ\text{C}$	-	3.4	4	V
			$T_C = 175^\circ\text{C}$	-	2.7	-	
t_{rr}	Diode Reverse Recovery Time	$V_R = 600\text{ V}, I_F = 75\text{ A}, dI_F/dt = 500\text{ A}/\mu\text{s}$	$T_C = 25^\circ\text{C}$	-	99	-	ns
			$T_C = 175^\circ\text{C}$	-	329	-	
Q_{rr}	Diode Reverse Recovery Charge		$T_C = 25^\circ\text{C}$	-	1001	-	nC
			$T_C = 175^\circ\text{C}$	-	5696	-	
I_{rrm}	Diode Reverse Recovery Current		$T_C = 25^\circ\text{C}$	-	20	-	A
			$T_C = 175^\circ\text{C}$	-	34	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping
FGY75T120SQDN	FGY75T120SQDN	TO-247-3LD (Pb-Free)	30 / Tube

FGY75T120SQDN

TYPICAL CHARACTERISTICS

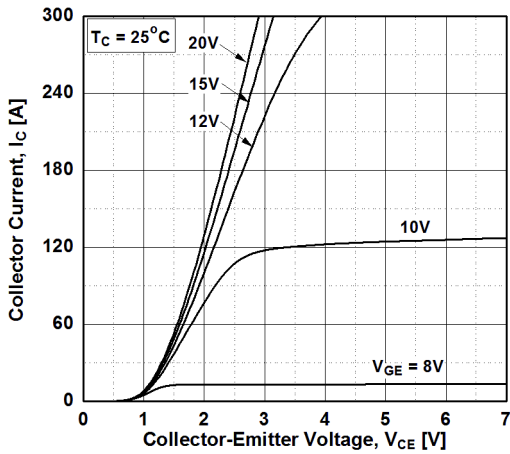


Figure 1. Typical Output Characteristics (25°C)

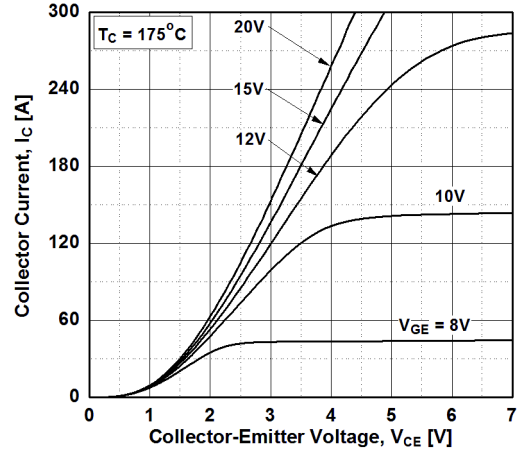


Figure 2. Typical Output Characteristics (175°C)

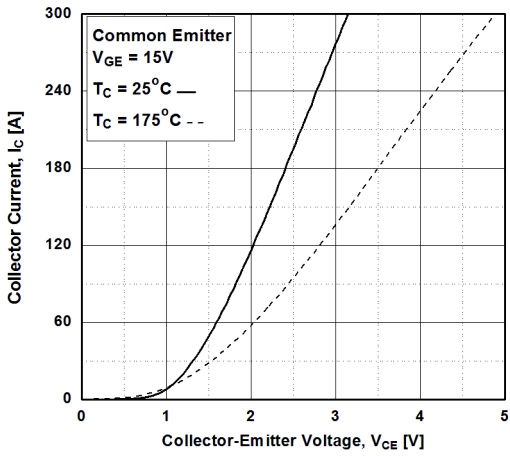


Figure 3. Typical Saturation Voltage Characteristics

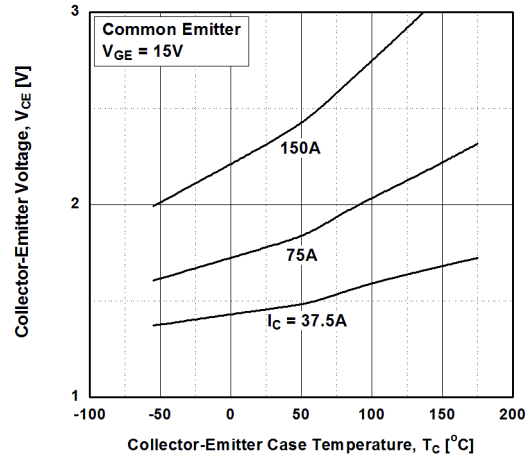


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

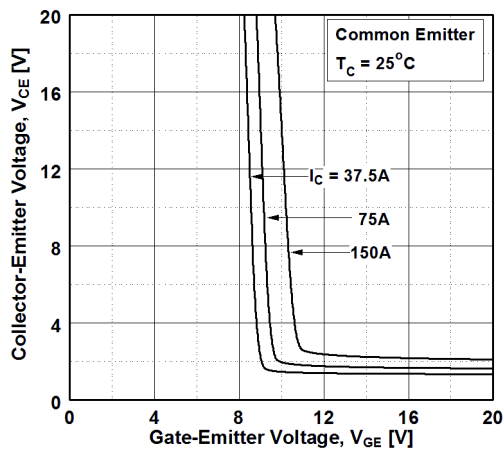


Figure 5. Saturation Voltage vs. V_{GE} (25°C)

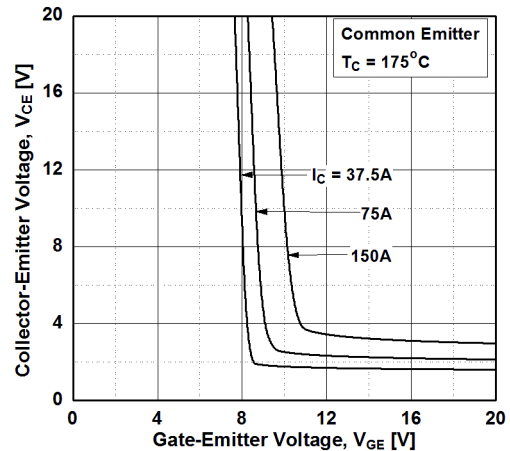


Figure 6. Saturation Voltage vs. V_{GE} (175°C)

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TYPICAL CHARACTERISTICS

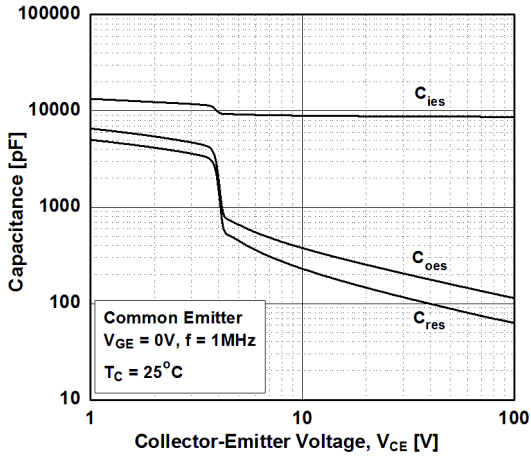


Figure 7. Capacitance Characteristics

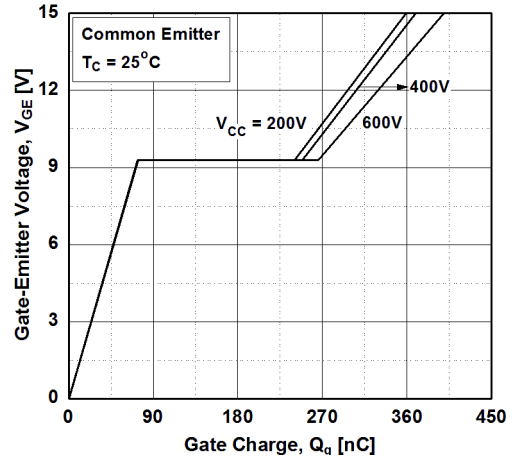


Figure 8. Gate Charge Characteristics

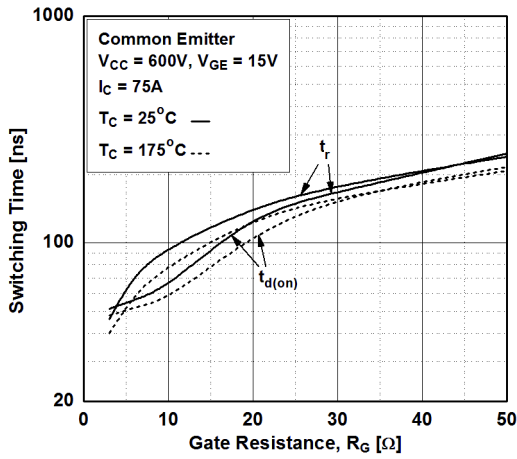


Figure 9. Turn-On Characteristics vs. Gate Resistance

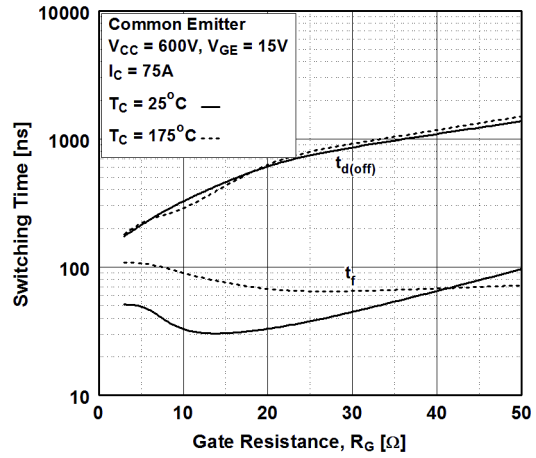


Figure 10. Turn-Off Characteristics vs. Gate Resistance

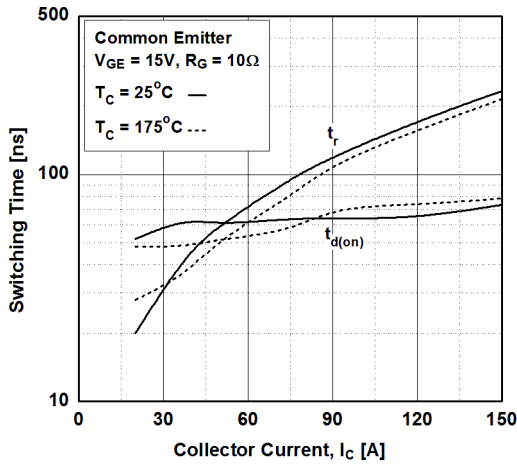


Figure 11. Turn-On Characteristics vs. Collector Current

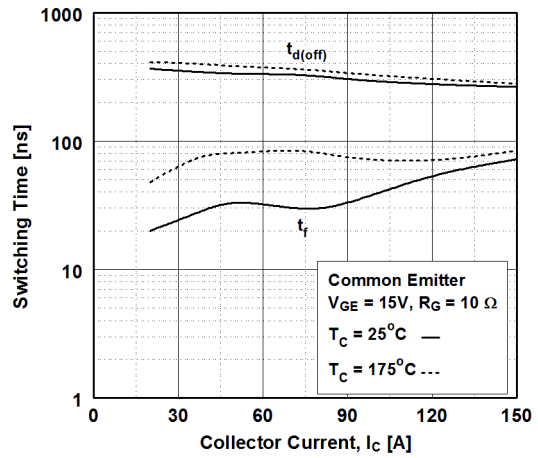


Figure 12. Turn-Off Characteristics vs. Collector Current

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TYPICAL CHARACTERISTICS

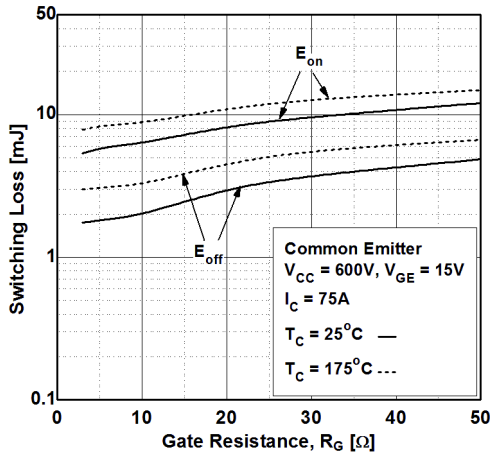


Figure 13. Switching Loss vs. Gate Resistance

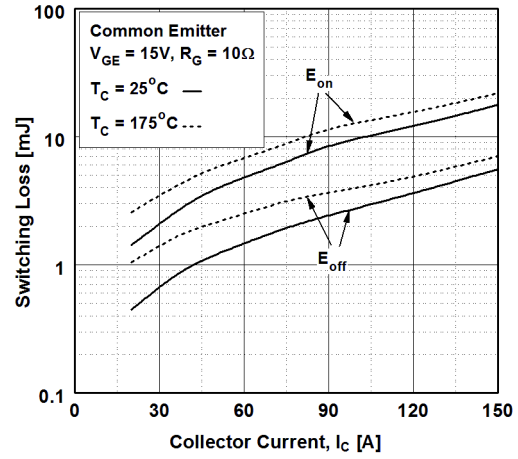


Figure 14. Switching Loss vs. Collector Current

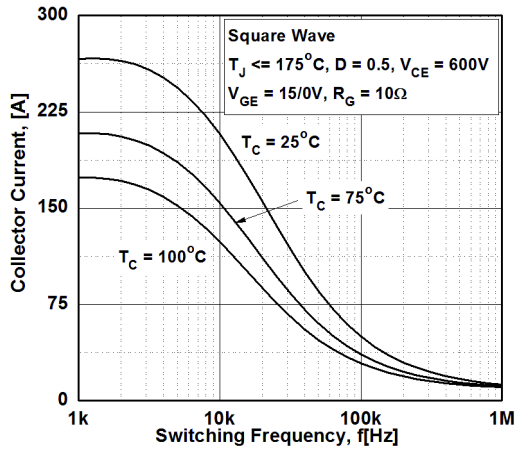


Figure 15. Load Current vs. Frequency

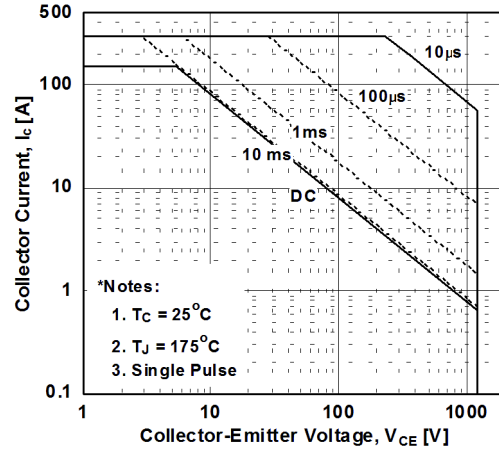


Figure 16. SOA Characteristics

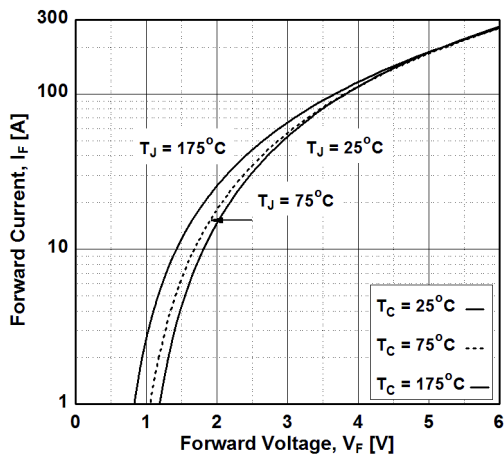


Figure 17. Forward Characteristics

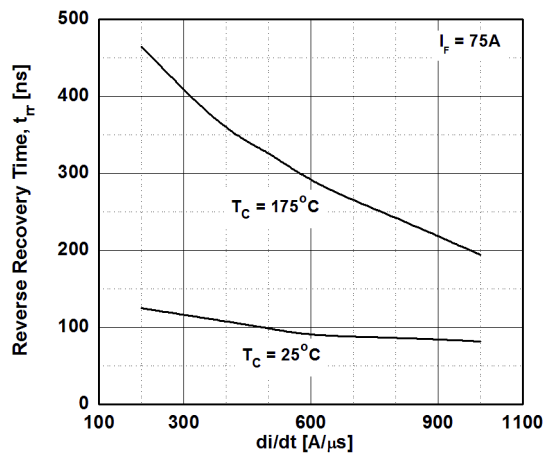


Figure 18. Reverse Recovery Time vs. di_F/dt

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TYPICAL CHARACTERISTICS

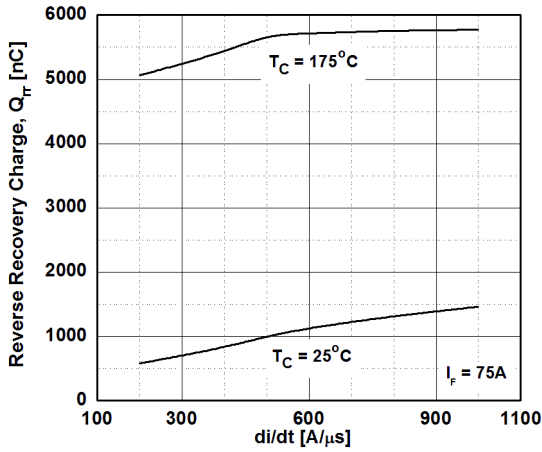


Figure 19. Reverse Recovery Charge vs. di_F/dt

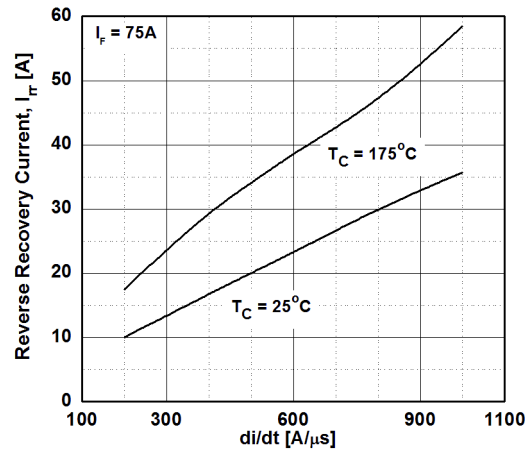


Figure 20. Reverse Recovery Current vs. di_F/dt

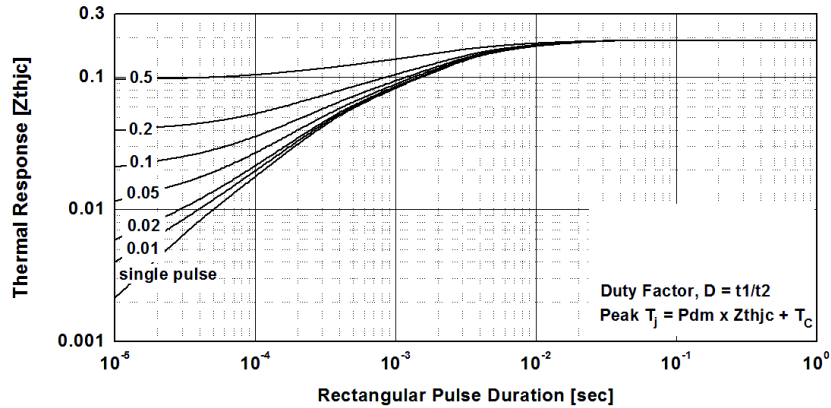


Figure 21. Transient Thermal Impedance of IGBT

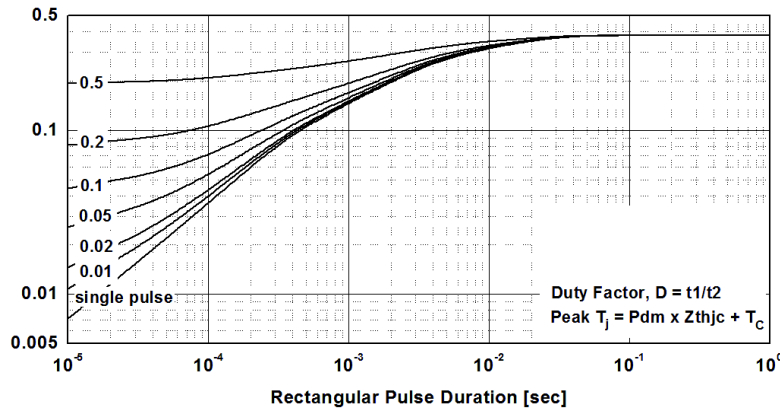


Figure 22. Transient Thermal Impedance of Diode

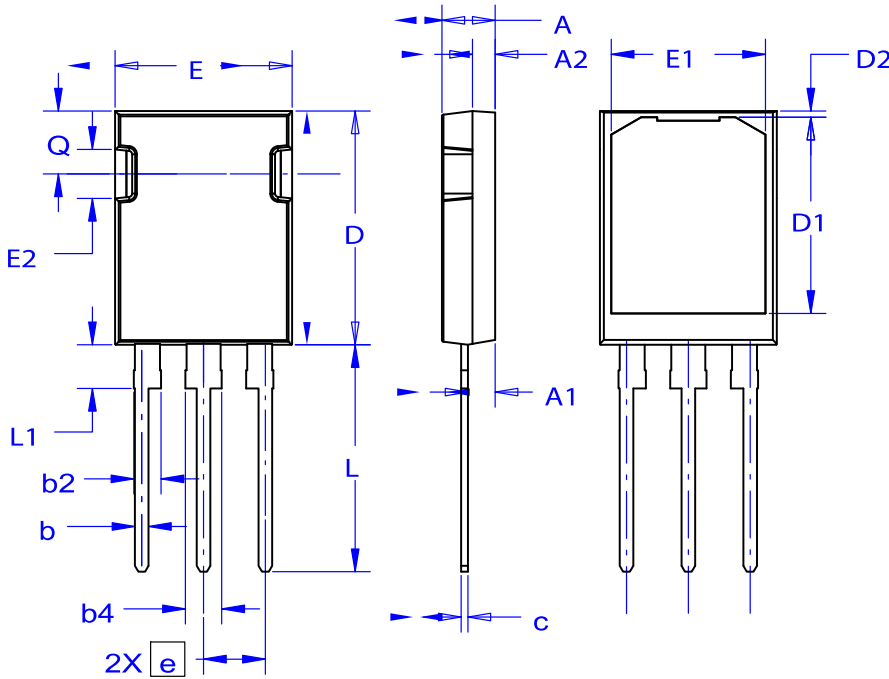
FGY75T120SQDN

PACKAGE DIMENSIONS


TO-247-3LD
CASE 340CD
ISSUE A

NOTES:

- A. THIS PACKAGE DOES NOT CONFORM TO ANY STANDARDS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- D. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.



DIM	MILLIMETERS		
	MIN	NOM	MAX
A	4.58	4.70	4.82
A1	2.20	2.40	2.60
A2	1.80	2.00	2.20
D	20.32	20.57	20.82
E	15.37	15.62	15.87
E2	4.12	4.32	4.52
e	~	5.45	~
L	19.90	20.00	20.10
L1	3.69	3.81	3.93
Q	5.34	5.46	5.58
b	1.10	1.20	1.30
b2	2.10	2.24	2.39
b4	2.87	3.04	3.20
c	0.51	0.61	0.71
D1	16.63	16.83	17.03
D2	0.51	0.93	1.35
E1	13.40	13.60	13.80

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